PCN Number:		20190108000.0 P				Date:	January 23, 2019					
Title: Datasheet for TMP102												
Customer Contact:			PCN Manager					Dept:		Quality Services		
Change Type:												
	Assembly Site				Design				Wafer Bump Site			
Assembly Process				\boxtimes						Wafer Bump Material		
Assembly Materials				Щ	Part number change					Wafer Bump Process		
Mechanical Specificati				Щ	Test Site			1 📙		Wafer Fab Site		
Packing/Shipping/L			abeling	Test Process					_	er Fab Materials		
Natification F						D	otoile		Wat	er Fab Process		
Notification Details Possible of Change												
Description of Change: Texas Instruments Incorporated is announcing an information only notification.												
The product datasheet(s) is being updated as summarized below. The following change history provides further details.												
TEXAS INSTRUMENTS SBOS397H—AUGUST 2007—REVISED DECEMBER 2018												
Changes from Revision G (September 2018) to Revision H Page												
Changed Absolute Maximum Ratings for voltage at SCL, SDA and ADD0 pin												
Changed Absolute Maximum Ratings for voltage at SCL, SDA and Abbo pin												
The state of the s												
The datasheet number will be changing.												
Device Family							Change From:			Change To:		
TI	4P102	2					SBOS397G			SBOS397H		
These changes may be reviewed at the datasheet links provided.												
http://www.ti.com/product/TMP102												
Reason for Change:												
To accurately reflect device characteristics.												
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):												
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.												
Changes to product identification resulting from this PCN:												
None.												
Product Affected:												
		330AIDRLR	HPA0033	0A	IDRLRG4	TMP	102AIDRL	.R		TMP102AIDRLRG4		
TI	4P102	2AIDRLT	TMP102A	IDF	RLTG4							
			1									

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com